

January 1989

Dual SPST CMOS Analog Switch

Features

- This Circuit is Processed in Accordance to MII-Std-883 and is Fully Conformant Under the Provisions of Paragraph 1.2.1.
- Wide Analog Signal Range $\pm 15V$
- Low "ON" Resistance 25 Ω (Typ)
50 Ω (Max)
- High Current Capability 70mA (Max)
- Break-Before-Make Switching
 - ▶ Turn-On Time 370ns (Typ)
800ns (Max)
 - ▶ Turn-Off Time 280ns (Typ)
400ns (Max)
- No Latch-Up
- Input MOS Gates Are Protected From Electrostatic Discharge
- DTL, TTL, CMOS, PMOS Compatible

Applications

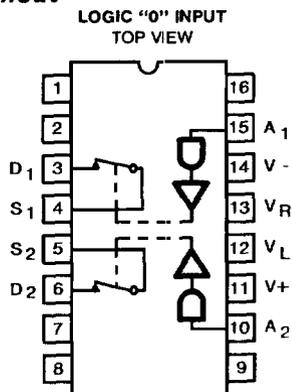
- High Frequency Switching
- Sample and Hold
- Digital Filters
- Operational Amplifier Gain Switching

Description

This CMOS analog switch offers low-resistance switching performance for analog voltages up to the supply rails and for signal currents up to 70mA. "ON" resistance is low and stays reasonably constant over the full range of operating signal voltage and current. R_{ON} remains exceptionally constant for input voltages between +5V and -5V and currents up to 50mA. Switch impedance also changes very little over temperature, particularly between 0°C and +75°C. R_{ON} is nominally 25 Ω .

This device provides break-before-make switching and is TTL and CMOS compatible for maximum application versatility. Performance is further enhanced by Dielectric Isolation processing which insures latch-free operation with very low input and output leakage currents (0.8nA at +25°C). This switch also features very low power operation (1.5mW at +25°C). The HI-5048/883 is available in a 16 pin Ceramic DIP and operates over the -55°C to +125°C temperature range.

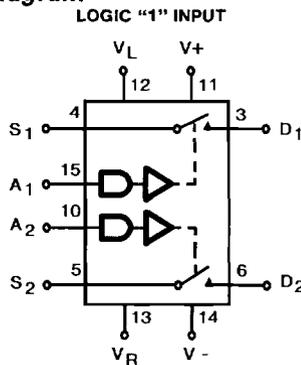
Pinout



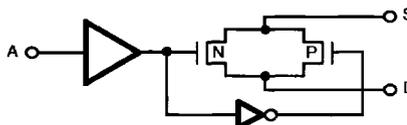
HI1-5048/883 (CERAMIC DIP)

NOTE: Unused pins may be internally connected. Ground all unused pins.

Functional Diagram



TYPICAL SWITCH



NOTE: Source and Drain are arbitrarily depicted as Analog Input and Output respectively. They may be interchanged without affecting performance.

Specifications HI-5048/883

Absolute Maximum Ratings

Voltage Between V+ and V- Terminals	36V
$\pm V_{SUPPLY}$ to Ground (V+, V-)	$\pm 18V$
V _R to Ground	-V _{SUPPLY}
V _L to Ground	+V _{SUPPLY}
Digital and Analog Input Voltage (V _A , V _S , V _D)	+V _{SUPPLY} +4V -V _{SUPPLY} -4V

Peak Current (Source to Drain) (Pulse at 1ms, 10% Duty Cycle Max)	70mA
Continuous Current (Any Pin)	20mA
Junction Temperature	+175°C
Storage Temperature Range	-65°C to +150°C
ESD Rating	< 2000V
Lead Temperature (Soldering 10 sec)	300°C

Thermal Information

Thermal Resistance	θ_{ja}	θ_{jc}
Ceramic DIP Package	82°C/W	20°C/W
Package Power Dissipation Limit at +75°C for T _J ≤ +175°C	Ceramic DIP Package	
	1.0W	
Package Power Dissipation Derating Factor Above +75°C	Ceramic DIP Package	
	12.3mW/°C	

CAUTION: Absolute maximum ratings are limiting values, applied individually, beyond which the serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied.

Recommended Operating Conditions

Operating Temperature Range	-55°C to +125°C
Operating Supply Voltage	$\pm 15V$
Logic Supply Voltage (V _L)	+5.0V
Logic Reference Voltage (V _R)	0.0V

Analog Input Voltage (V _S)	$\pm V_{SUPPLY}$
Address Low Level (V _{AL})	0V to 0.8V
Address High Level (V _{AH})	2.4V to +5.0V

TABLE 1. D.C. ELECTRICAL PERFORMANCE CHARACTERISTICS

Device Tested at: Supply Voltage = $\pm 15V$, V_L = +5.0V, V_R = 0.0V, V_{AH} = 2.4V, V_{AL} = +0.8V, Unused Pins are Grounded, Unless Otherwise Specified.

D.C. PARAMETERS	SYMBOL	CONDITIONS	GROUP A SUBGROUP	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Switch "ON" Resistance	R _{DS}	V _D = -10V, I _S = 10mA S1/S2	1	+25°C	-	45	Ω
			2,3	-55°C to +125°C	-	50	Ω
		V _D = 10V, I _S = -10mA S1/S2	1	+25°C	-	45	Ω
			2,3	-55°C to +125°C	-	50	Ω
Source "OFF" Leakage Current	I _{S(OFF)}	V _S = -10V, V _D = 10V S1/S2	1	+25°C	-1	1	nA
			2,3	-55°C to +125°C	-100	100	nA
		V _S = 10V, V _D = -10V S1/S2	1	+25°C	-1	1	nA
			2,3	-55°C to +125°C	-100	100	nA
Drain "OFF" Leakage Current	I _{D(OFF)}	V _D = -10V, V _S = 10V S1/S2	1	+25°C	-1	1	nA
			2,3	-55°C to +125°C	-100	100	nA
		V _D = 10V, V _S = -10V S1/S2	1	+25°C	-1	1	nA
			2,3	-55°C to +125°C	-100	100	nA
Channel "ON" Leakage Current	I _{D(ON)}	V _D = V _S = 10V S1/S2	1	+25°C	-2	2	nA
			2,3	-55°C to +125°C	-200	200	nA
		V _D = V _S = -10V S1/S2	1	+25°C	-2	2	nA
			2,3	-55°C to +125°C	-200	200	nA
Low Level Address Current	I _{AL}	V _A = 0V A ₁ , A ₂	1	+25°C	-1	1	μA
			2,3	-55°C to +125°C	-10	1	μA
High Level Address Current	I _{AH}	V _A = 2.4V, 5V A ₁ , A ₂	1	+25°C	-1	1	μA
			2,3	-55°C to +125°C	-1	10	μA
Positive Supply Current	+I _{CC}	V _A = 0V, 5V A ₁ , A ₂	1	+25°C	-	200	μA
			2,3	-55°C to +125°C	-	300	μA
Negative Supply Current	-I _{CC}	V _A = 0V, 5V A ₁ , A ₂	1	+25°C	-200	-	μA
			2,3	-55°C to +125°C	-300	-	μA
Logic Supply Current	+I _L	V _A = 0V, 5V	1	+25°C	-	200	μA
			2,3	-55°C to +125°C	-	300	μA
Reference Supply Current	+I _R	V _A = 0V, 5V	1	+25°C	-200	-	μA
			2,3	-55°C to +125°C	-300	-	μA

CAUTION: This device is sensitive to electrostatic discharge. Proper I.C. handling procedures should be followed.

TABLE 2. A.C. ELECTRICAL PERFORMANCE CHARACTERISTICS

Device Tested at: Supply Voltage = ±15V, V_L = +5.0V, V_R = 0.0V, V_{AH} = +5.0V, V_{AL} = +0.0V, Unused Pins are Grounded, Unless Otherwise Specified.

PARAMETERS	SYMBOL	CONDITIONS	GROUP A SUBGROUP	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Turn "ON" Time	t _{ON}	V _S = 10V, -10V C _L = 10pF R _L = 1kΩ	11	-55°C	-	450	ns
			9	+25°C	-	500	ns
			10	+125°C	-	800	ns
Turn "OFF" Time	t _{OFF}	V _S = 10V, -10V C _L = 10pF R _L = 1kΩ	11	-55°C	-	350	ns
			9	+25°C	-	450	ns
			10	+125°C	-	600	ns

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS (NOTE 1)

Device Characterized at: Supply Voltage = ±15V, V_L = +5.0V, V_R = 0.0V, V_{AH} = 4.0V, V_{AL} = 0.8V, Unused Pins are Grounded, Unless Otherwise Specified.

PARAMETERS	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
"On" Resistance Match (Channel to Channel)	R _{ON} Match	V _D = ±10V I _D = 10mA	1	+25°C	-	10	Ω
Address Capacitance	C _A	V _A = 0V, 5V	1	+25°C	-	45	pF
Switch Input Capacitance	C _S (OFF)	Switch Off: V _A = 0V	1	+25°C	-	60	pF
Switch Output Capacitance	C _D (OFF)	Switch Off: V _A = 0V	1	+25°C	-	60	pF
	C _D (ON)	Switch On: V _A = 5V	1	+25°C	-	60	pF
Drain to Source Capacitance	C _{DS} (OFF)	Switch Off: V _A = 0V	1	+25°C	-	10	pF
Off Isolation	V _{ISO}	V _S = 2V _{p-p} @ f = 100kHz R _L = 100Ω	1	+25°C	-	60	dB
Crosstalk	V _{CT}	V _S = 2V _{p-p} @ f = 100kHz R _L = 100Ω	1	+25°C	-	60	dB
Charge Transfer Error	V _{CTE}	V _S = GND, C _L = 10,000pF V _A = 0 to 4V @ f = 200kHz	1	+25°C	-	30	mV

NOTE 1. Parameters listed in Table 3 are controlled via design or process parameters and are not directly tested at final production. These parameters are lab characterized upon initial design release, or upon design changes. These parameters are guaranteed by characterization based upon data from multiple production runs which reflect lot to lot and within lot variation.

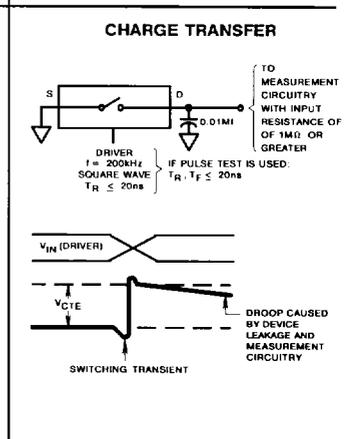
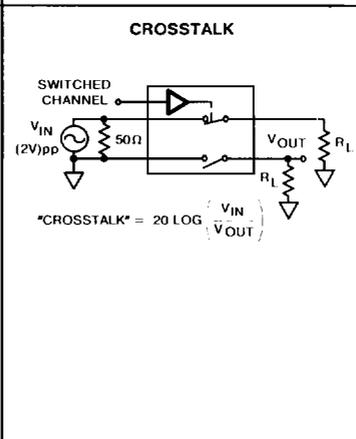
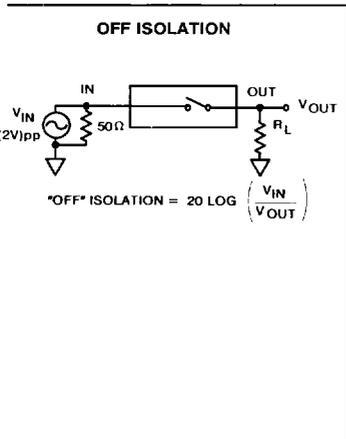
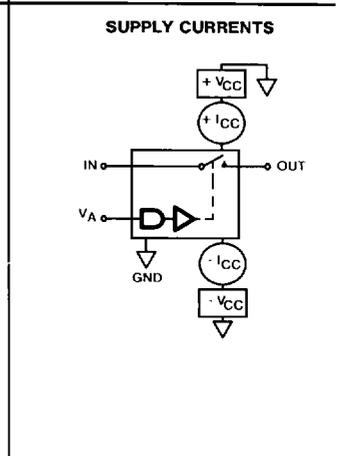
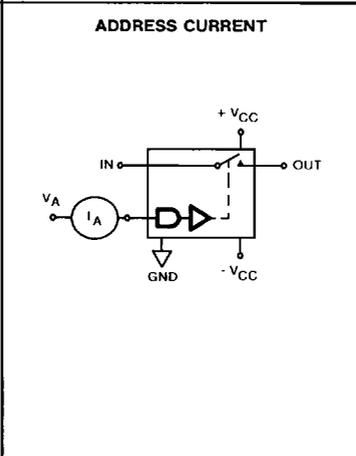
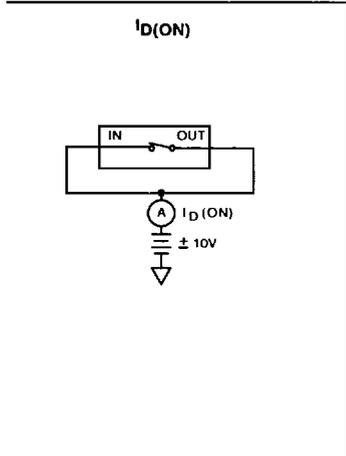
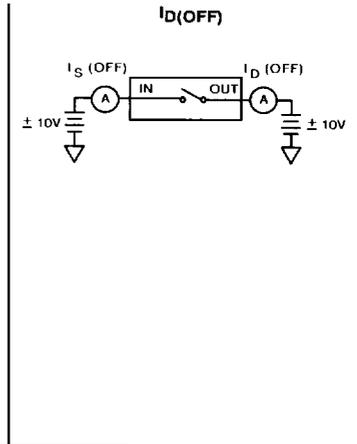
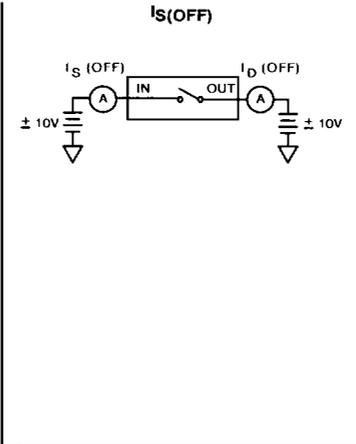
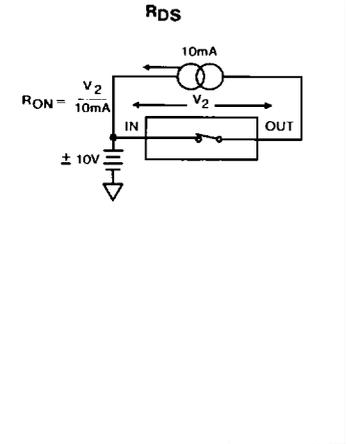
TABLE 4. ELECTRICAL TEST REQUIREMENTS

MIL-STD-883 TEST REQUIREMENTS	SUBGROUPS (SEE TABLES 1 & 2)
Interim Electrical Parameters (Pre Burn-in)	1
Final Electrical Test Parameters	1*, 2, 3, 9, 10, 11
Group A Test Requirements	1, 2, 3, 9, 10, 11
Groups C & D Endpoints	1

* PDA applies to Subgroup 1 only.

4
CMOS ANALOG SWITCHES

Test Circuits

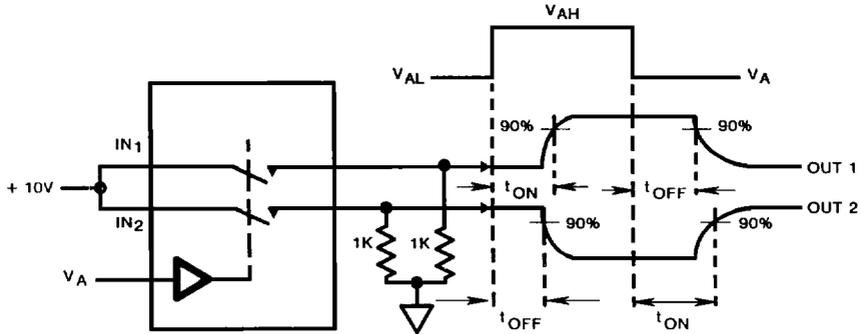


NOTE: Applies only to DUAL or DOUBLE THROW switches.

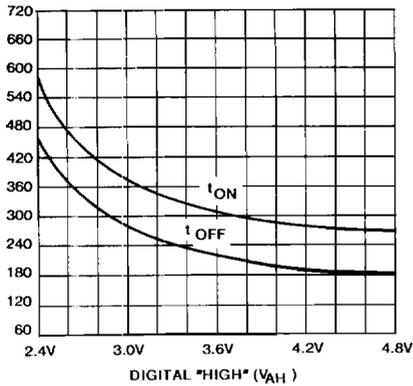
NOTE: V_{CTE} may be a positive or negative value.

Test Characteristics

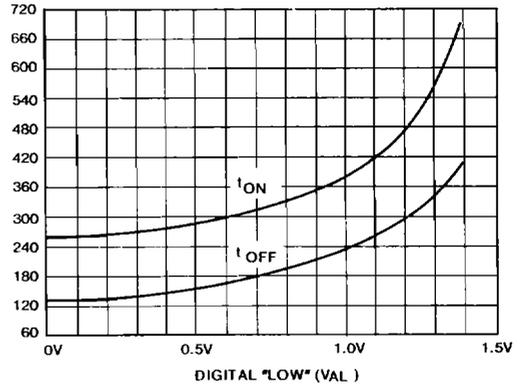
ON/OFF SWITCH TIME (t_{ON} , t_{OFF})



SWITCHING TIMES FOR POSITIVE DIGITAL TRANSITION

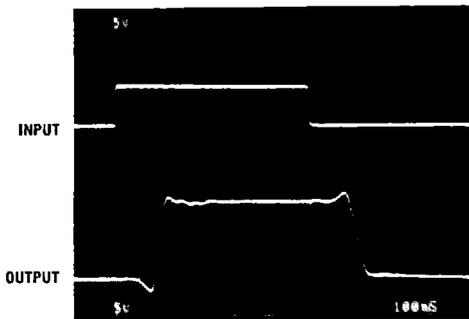


SWITCHING TIMES FOR NEGATIVE DIGITAL TRANSITION

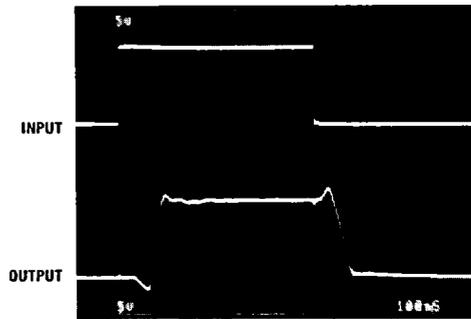


Test Waveforms

Vertical Scale: Input = 5V/Div., (TTL; $V_{AH} = 5V$, $V_{AL} = 0V$)
 Output = 5V/Div.
 Horizontal Scale: 100ns/Div.



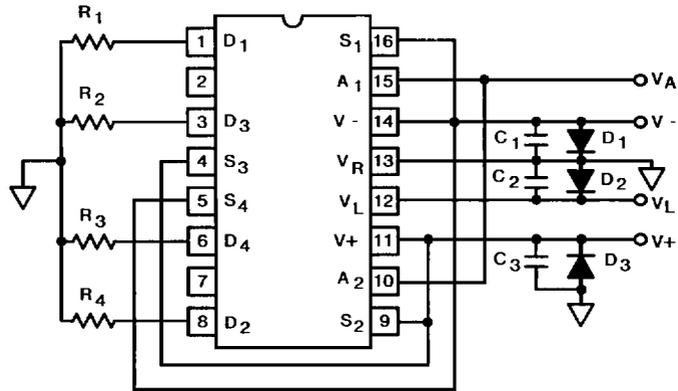
Vertical Scale: Input = 5V/Div., (CMOS; $V_{AH} = 10V$, $V_{AL} = 0V$)
 Output = 5V/Div.
 Horizontal Scale: 100ns/Div.



HI-5048/883

Burn-In Circuit

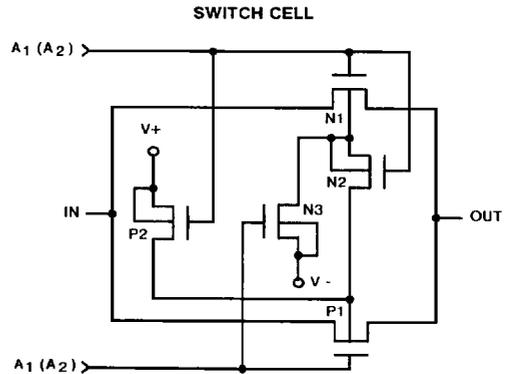
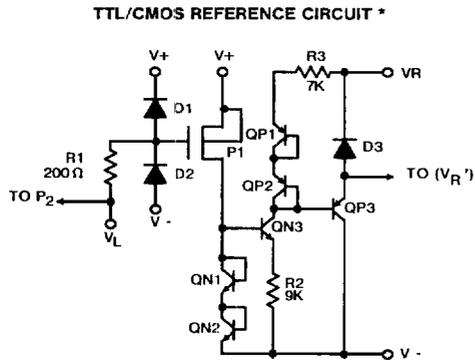
HI-5048/883 CERAMIC DIP



NOTES:

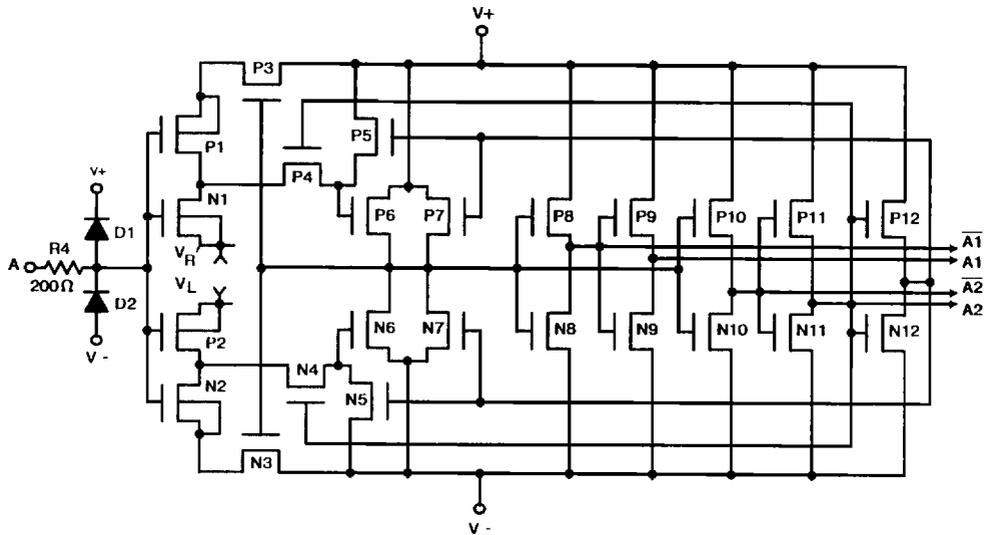
- R₁ thru R₄ = 10kΩ, ±5%, 1/4W (Min)
- C₁, C₂, C₃, = 0.01μF/Socket (Min) or 0.1μF/Row, (Min)
- D₁, D₂, D₃ = 1N4002 or Equivalent/Board
- V_L = 5.5 ± 0.5V
- A₁ = A₂ = 5.5 ± 0.5V
- |V₊ - V₋| = 30V

Schematic Diagram



* Connect V+ to V_L for minimizing power consumption when driving from CMOS circuits.

DIGITAL INPUT BUFFER AND LEVEL SHIFTER



All N-Channel Bodies to V-
All P-Channel Bodies to V+
Except as Shown

Die Characteristics

DIE DIMENSIONS:

96 x 81 x 19mils
(2430 x 2050 x 480μm)

METALLIZATION:

Type: Aluminum
Thickness: $16k\text{\AA} \pm 2k\text{\AA}$

GLASSIVATION:

Type: Nitride over Silox
Silox Thickness: $12k\text{\AA} \pm 2k\text{\AA}$
Nitride Thickness: $3.5k\text{\AA} \pm 1k\text{\AA}$

SUBSTRATE POTENTIAL (Powered-up): V-

DEVICE COUNT: 82

DIE ATTACH:

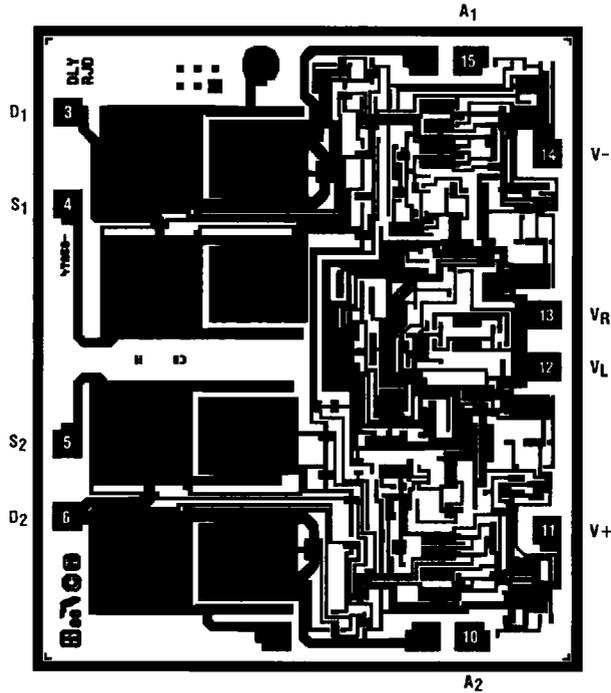
Material: Gold/Silicon Eutectic Alloy
Temperature: Ceramic DIP — 460°C (Max)

WORST CASE CURRENT DENSITY:

$1.0 \times 10^5\text{A/cm}^2$ @ 20mA

Metallization Mask Layout

HI-5048/883



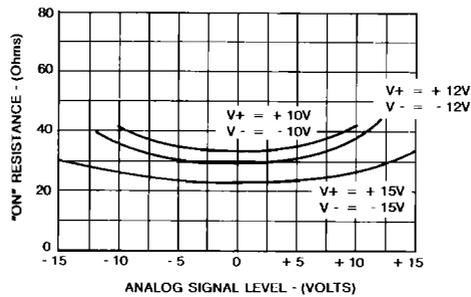
NOTE: Pin Numbers Correspond to DIP Package Only. Unused Pins May Be Connected. Ground All Unused Pins.

DESIGN INFORMATION
Dual SPST CMOS Analog Switch

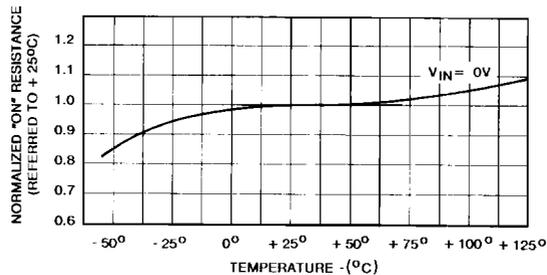
The information contained in this section has been developed through characterization by Harris Semiconductor and is for use as application and design aid only. These characteristics are not 100% tested and no product guarantee is implied.

Typical Performance Curves Unless Otherwise Specified: $T_A = +25^\circ\text{C}$, $V_{\text{SUPPLY}} = \pm 15\text{V}$

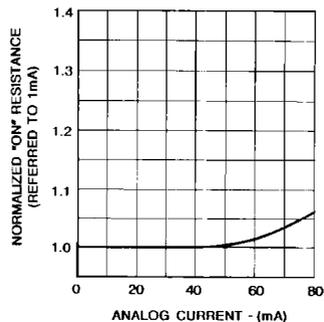
"ON" RESISTANCE vs. ANALOG SIGNAL LEVEL AND POWER SUPPLY VOLTAGE



NORMALIZED "ON" RESISTANCE vs. TEMPERATURE



NORMALIZED "ON" RESISTANCE vs. ANALOG CURRENT

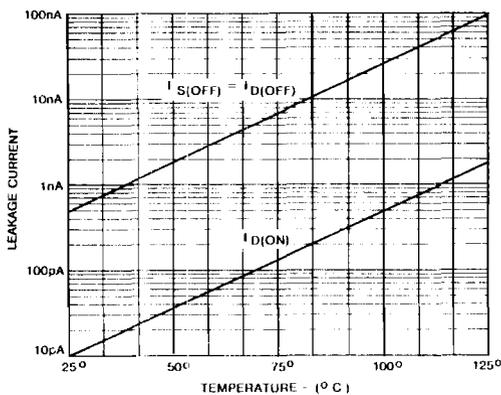


DESIGN INFORMATION (Continued)

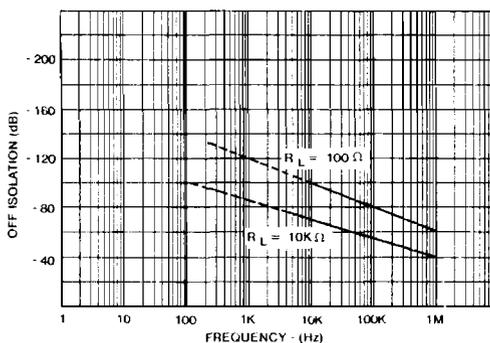
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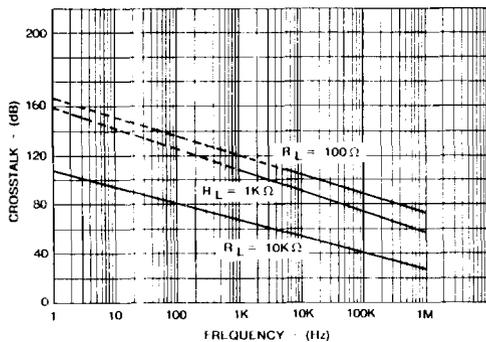
ON/OFF LEAKAGE CURRENT vs. TEMPERATURE



"OFF" ISOLATION vs. FREQUENCY



CROSSTALK vs. FREQUENCY



POWER CONSUMPTION vs. FREQUENCY

